

20-bit bus-interface D-type flip-flop; positive-edge trigger (3-State)

74ALVCH16821

FEATURES

- Wide supply voltage range of 1.2V to 3.6V
- Complies with JEDEC standard no. 8-1A
- Current drive ± 24 mA at 3.0 V
- CMOS low power consumption
- Direct interface with TTL levels
- MULTIBYTE™ flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and ground pins for minimum noise and ground bounce
- All data inputs have bus hold
- Output drive capability 50 Ω transmission lines @ 85°C

QUICK REFERENCE DATA

GND = 0V; $T_{amb} = 25^{\circ}\text{C}$; $t_r = t_f \leq 2.5\text{ns}$

SYMBOL	PARAMETER	CONDITIONS	TYPICAL	UNIT
t_{PHL}/t_{PLH}	Propagation delay nCP to nQ _n	$V_{CC} = 2.5\text{V}, C_L = 30\text{pF}$ $V_{CC} = 3.3\text{V}, C_L = 50\text{pF}$	2.6 2.5	ns
C_I	Input capacitance		5.0	pF
C_{PD}	Power dissipation capacitance per buffer	$V_I = \text{GND to } V_{CC}^1$	Outputs enabled 33 Outputs disabled 17	pF
F_{max}	Maximum clock frequency	$V_{CC} = 2.5\text{V}, C_L = 30\text{pF}$ $V_{CC} = 3.3\text{V}, C_L = 50\text{pF}$	250 350	MHz

NOTE:

- C_{PD} is used to determine the dynamic power dissipation (P_D in W):
 $P_D = C_{PD} \times V_{CC}^2 \times f_i + (C_L \times V_{CC}^2 \times f_o)$ where:
 f_i = input frequency in MHz; C_L = output load capacitance in pF;
 f_o = output frequency in MHz; V_{CC} = supply voltage in V;
 $(C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

ORDERING INFORMATION

PACKAGES	TEMPERATURE RANGE	OUTSIDE NORTH AMERICA	NORTH AMERICA	DWG NUMBER
56-Pin Plastic SSOP Type III	-40°C to +85°C	74ALVCH16821 DL	ACH16821 DL	SOT371-1
56-Pin Plastic TSSOP Type II	-40°C to +85°C	74ALVCH16821 DGG	ACH16821 DGG	SOT364-1

DESCRIPTION

The 74ALVCH16821 has two 10-bit, edge triggered registers, with each register coupled to a 3-State output buffer. The two sections of each register are controlled independently by the clock (nCP) and Output Enable (nOE) control gates.

Each register is fully edge triggered. The state of each D input, one set-up time before the Low-to-High clock transition, is transferred to the corresponding flip-flop's Q output.

When nOE is LOW, the data in the register appears at the outputs. When nOE is HIGH, the outputs are in high impedance OFF state. Operation of the nOE input does not affect the state of the flip-flops.

The 74ALVCH16821 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

20-bit bus-interface D-type flip-flop; positive-edge trigger (3-State)

74ALVCH16821

PIN DESCRIPTION

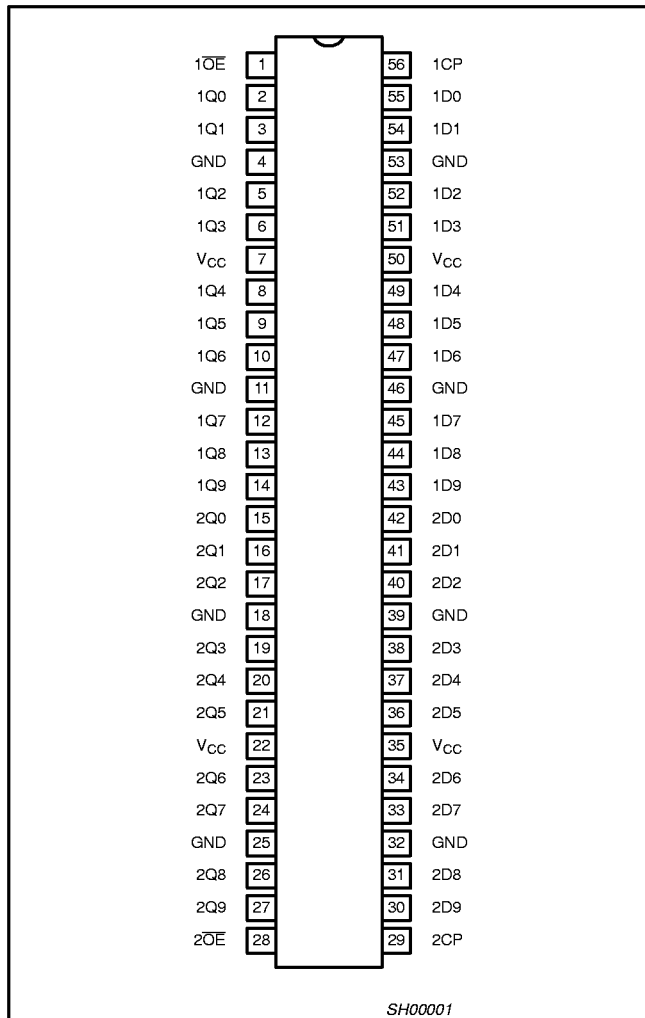
PIN NUMBER	SYMBOL	FUNCTION
55, 54, 52, 51, 49, 48, 47, 45, 44, 43	1D0 - 1D9	Data inputs
42, 41, 40, 38, 37, 36, 34, 33, 31, 30	2D0 - 2D9	
2, 3, 5, 6, 8, 9, 10, 12, 13, 14	1Q0 - 1Q9	Data outputs
15, 16, 17, 19, 20, 21, 23, 24, 26, 27	2Q0 - 2Q9	
1, 28	1OE, 2OE	Output enable inputs (active-Low)
56, 29	1CP, 2CP	Clock pulse inputs (active rising edge)
4, 11, 18, 25, 32, 39, 46, 53	GND	Ground (0V)
7, 22, 35, 50	V _{CC}	Positive supply voltage

FUNCTION TABLE

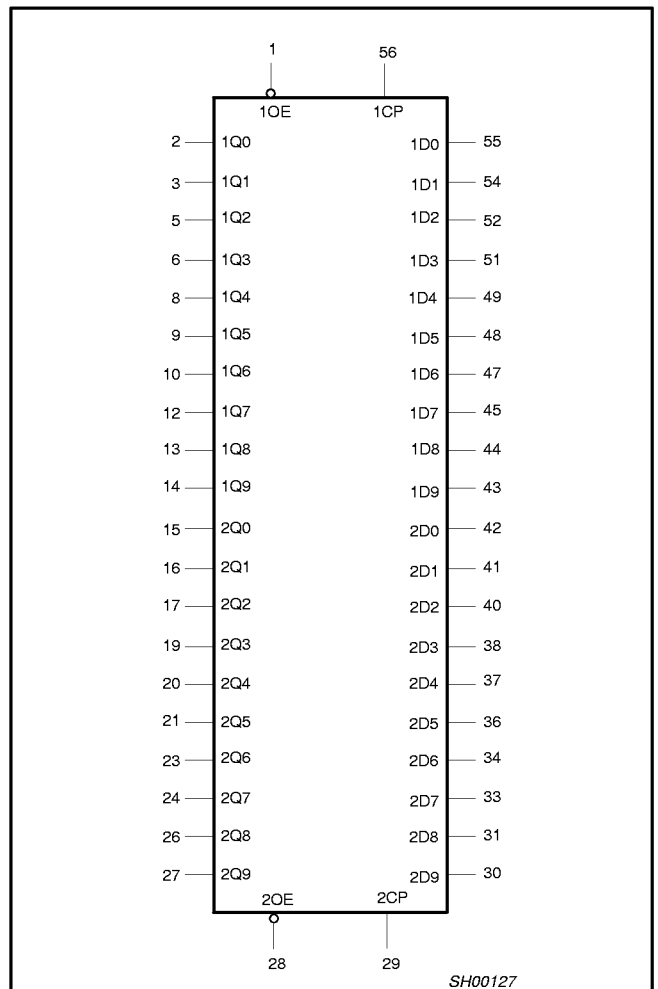
INPUTS			OUTPUT
nOE	CP	Dx	Q
L	↑	L	L
L	↑	H	H
L		X	Q0
H	X	X	Z

H = HIGH voltage level
 L = LOW voltage level
 X = Don't care
 Z = High impedance OFF state
 ↑ = LOW to HIGH clock transition
 = Not a LOW-to-HIGH clock transition

PIN CONFIGURATION



LOGIC SYMBOL



20-bit bus-interface D-type flip-flop;
positive-edge trigger (3-State)

74ALVCH16821

RECOMMENDED OPERATING CONDITIONS

SYMBOL	PARAMETER	CONDITIONS	LIMITS		UNIT
			MIN	MAX	
V _{CC}	DC supply voltage 2.5V range (for max. speed performance @ 30 pF output load)		2.3	2.7	V
	DC supply voltage 3.3V range (for max. speed performance @ 50 pF output load)		3.0	3.6	
V _I	DC Input voltage range		0	V _{CC}	V
V _O	DC output voltage range		0	V _{CC}	V
T _{amb}	Operating free-air temperature range		-40	+85	°C
t _r , t _f	Input rise and fall times	V _{CC} = 2.3 to 3.0V	0	20	ns/V
		V _{CC} = 3.0 to 3.6V	0	10	

ABSOLUTE MAXIMUM RATINGS

In accordance with the Absolute Maximum Rating System (IEC 134)

Voltages are referenced to GND (ground = 0V)

SYMBOL	PARAMETER	CONDITIONS	RATING	UNIT
V _{CC}	DC supply voltage		-0.5 to +4.6	V
I _{IK}	DC input diode current	V _I = 0	-50	mA
V _I	DC input voltage	For control pins ¹	-0.5 to +4.6	V
		For data inputs ¹	-0.5 to V _{CC} +0.5	
I _{OK}	DC output diode current	V _O = V _{CC} or V _O = 0	50	mA
V _O	DC output voltage	Note 1	-0.5 to V _{CC} +0.5	V
I _O	DC output source or sink current	V _O = 0 to V _{CC}	50	mA
I _{GND} , I _{CC}	DC V _{CC} or GND current		100	mA
T _{stg}	Storage temperature range		-65 to +150	°C
P _{TOT}	Power dissipation per package -plastic medium-shrink (SSOP) -plastic thin-medium-shrink (TSSOP)	For temperature range: -40 to +125 °C	850	mW
		above +55°C derate linearly with 11.3 mW/K above +55°C derate linearly with 8 mW/K	600	

NOTE:

1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

20-bit bus-interface D-type flip-flop;
positive-edge trigger (3-State)

74ALVCH16821

DC ELECTRICAL CHARACTERISTICS

Over recommended operating conditions. Voltage are referenced to GND (ground = 0 V).

SYMBOL	PARAMETER	TEST CONDITIONS	LIMITS			UNIT
			Temp = -40°C to +85°C			
			MIN	TYP ¹	MAX	
V _{IH}	HIGH level Input voltage	V _{CC} = 2.3 to 2.7V	1.7	1.2		V
		V _{CC} = 2.7 to 3.6V	2.0	1.5		
V _{IL}	LOW level Input voltage	V _{CC} = 2.3 to 2.7V		1.2	0.7	V
		V _{CC} = 2.7 to 3.6V		1.5	0.8	
V _{OH}	HIGH level output voltage	V _{CC} = 2.3 to 3.6V; V _I = V _{IH} or V _{IL} ; I _O = -100µA	V _{CC} * 0.2	V _{CC}		V
		V _{CC} = 2.3V; V _I = V _{IH} or V _{IL} ; I _O = -6mA	V _{CC} * 0.3	V _{CC} * 0.08		
		V _{CC} = 2.3V; V _I = V _{IH} or V _{IL} ; I _O = -12mA	V _{CC} * 0.6	V _{CC} * 0.26		
		V _{CC} = 2.7V; V _I = V _{IH} or V _{IL} ; I _O = -12mA	V _{CC} * 0.5	V _{CC} * 0.14		
		V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = -12mA	V _{CC} * 0.6	V _{CC} * 0.09		
		V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = -24mA	V _{CC} * 1.0	V _{CC} * 0.28		
V _{OL}	LOW level output voltage	V _{CC} = 2.3 to 3.6V; V _I = V _{IH} or V _{IL} ; I _O = 100µA		GND	0.20	V
		V _{CC} = 2.3V; V _I = V _{IH} or V _{IL} ; I _O = 6mA		0.07	0.40	V
		V _{CC} = 2.3V; V _I = V _{IH} or V _{IL} ; I _O = 12mA		0.15	0.70	V
		V _{CC} = 2.7V; V _I = V _{IH} or V _{IL} ; I _O = 12mA		0.14	0.40	
		V _{CC} = 3.0V; V _I = V _{IH} or V _{IL} ; I _O = 24mA		0.27	0.55	
I _I	Input leakage current	V _{CC} = 2.3 to 3.6V; V _I = V _{CC} or GND		0.1	5	µA
I _{OZ}	3-State output OFF-state current	V _{CC} = 2.7 to 3.6V; V _I = V _{IH} or V _{IL} ; V _O = V _{CC} or GND		0.1	10	µA
I _{CC}	Quiescent supply current	V _{CC} = 2.3 to 3.6V; V _I = V _{CC} or GND; I _O = 0		0.2	40	µA
ΔI _{CC}	Additional quiescent supply current	V _{CC} = 2.3V to 3.6V; V _I = V _{CC} - 0.6V; I _O = 0		150	750	µA
I _{BHL}	Bus hold LOW sustaining current	V _{CC} = 2.3V; V _I = 0.7V ²	45	-		µA
		V _{CC} = 3.0V; V _I = 0.8V ²	75	150		
I _{BHH}	Bus hold HIGH sustaining current	V _{CC} = 2.3V; V _I = 1.7V ²	-45			µA
		V _{CC} = 3.0V; V _I = 2.0V ²	-75	-175		
I _{BHLO}	Bus hold LOW overdrive current	V _{CC} = 3.6V ²	500			µA
I _{BHHO}	Bus hold HIGH overdrive current	V _{CC} = 3.6V ²	-500			µA

NOTES:

1. All typical values are at T_{amb} = 25°C.
2. Valid for data inputs of bus hold parts.

20-bit bus-interface D-type flip-flop;
positive-edge trigger (3-State)

74ALVCH16821

AC CHARACTERISTICS FOR $V_{CC} = 2.3V$ TO $2.7V$ RANGE

GND = 0V; $t_r = t_f \leq 2.0ns$; $C_L = 30pF$

SYMBOL	PARAMETER	WAVEFORM	LIMITS			UNIT
			$V_{CC} = 2.3$ to $2.7V$			
			MIN	TYP ¹	MAX	
t_{PLH}/t_{PHL}	Propagation delay nCP to nQ _n	1, 4	1.0	2.6	5.8	ns
t_{PZH}/t_{PZL}	3-State output enable time nOE _n to nQ _n	2, 4	1.0	2.8	6.6	ns
t_{PHZ}/t_{PLZ}	3-State output disable time nOE _n to nQ _n	2, 4	1.0	2.2	5.7	ns
t_W	nCP pulse width HIGH or LOW	3, 4	3.0	1.8		ns
t_{SU}	Set up time nD _n to nCP	3, 4	1.4	0.3		ns
t_h	Hold time nD _n to nCP	3, 4	0.4	0.0		ns
F_{max}	Maximum clock pulse frequency	1, 4	150	250		MHz

NOTE:

1. All typical values are at $V_{CC} = 2.5V$ and $T_{amb} = 25^\circ C$.

AC CHARACTERISTICS FOR $V_{CC} = 3.0V$ TO $3.6V$ RANGE AND $V_{CC} = 2.7V$

GND = 0V; $t_r = t_f \leq 2.5ns$; $C_L = 50pF$

SYMBOL	PARAMETER	WAVEFORM	LIMITS						UNIT
			$V_{CC} = 3.3 \pm 0.3V$			$V_{CC} = 2.7V$			
			MIN	TYP ^{1, 2}	MAX	MIN	TYP ¹	MAX	
t_{PHL}/t_{PLH}	Propagation delay nCP to nQ _n	1, 4	1.0	2.5	4.5	1.0	2.8	5.3	ns
t_{PZH}/t_{PZL}	3-State output enable time nOE _n to nQ _n	2, 4	1.0	2.3	5.1	1.0	3.2	6.2	ns
t_{PHZ}/t_{PLZ}	3-State output disable time nOE _n to nQ _n	2, 4	1.0	2.8	4.6	1.0	3.1	5.0	ns
t_W	nCP pulse width HIGH or LOW	3, 4	3.3	0.2		3.3	1.7		ns
t_{SU}	Set up time nD _n to nCP	3, 4	1.0	0.2		1.2	0.3		ns
t_h	Hold time nD _n to nCP	3, 4	0.8	0.4		0.6	-0.3		ns
F_{max}	Maximum clock pulse frequency	1, 4	150	350		150	300		MHz

NOTES:

1. All typical values are at $T_{amb} = 25^\circ C$.

2. All typical values are at $V_{CC} = 3.3V$

20-bit bus-interface D-type flip-flop; positive-edge trigger (3-State)

74ALVCH16821

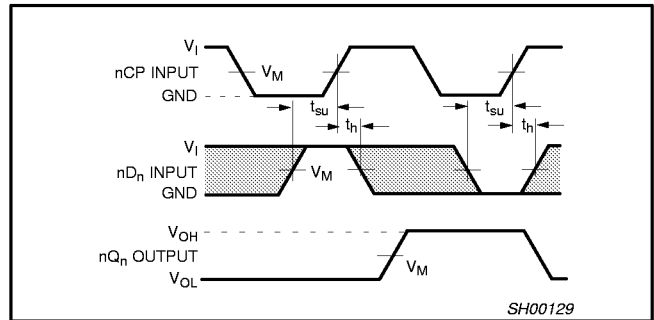
AC WAVEFORMS

V_{CC} = 2.3 TO 2.7 V RANGE

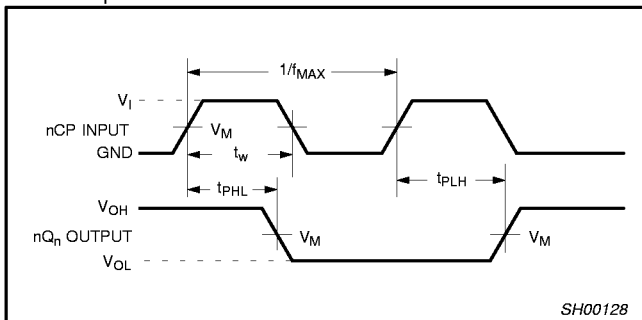
1. V_M = 0.5 V
2. V_X = V_{OL} + 0.15V
3. V_Y = V_{OH} - 0.15V
4. V_I = V_{CC}
5. V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.

V_{CC} = 3.0 TO 3.6 V RANGE AND V_{CC} = 2.7 V

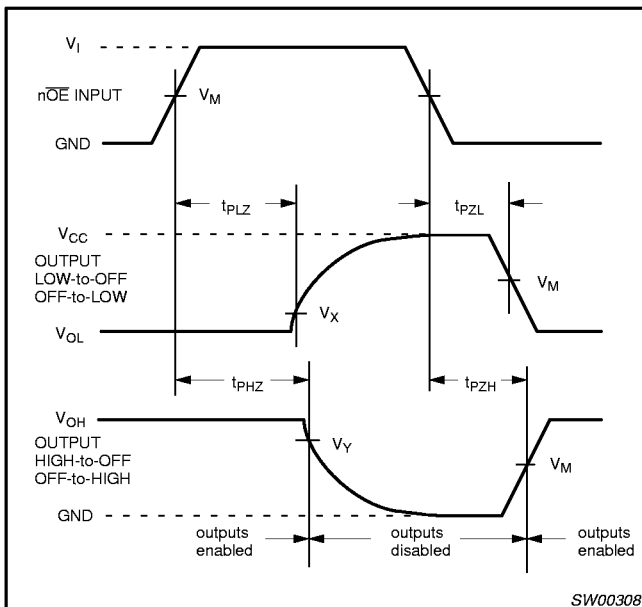
1. V_M = 1.5 V
2. V_X = V_{OL} + 0.3V
3. V_Y = V_{OH} - 0.3V
4. V_I = 2.7 V
5. V_{OL} and V_{OH} are the typical output voltage drop that occur with the output load.



Waveform 3. Set up and hold times.

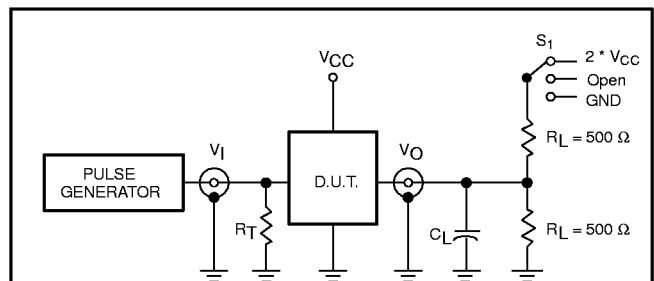


Waveform 1. The input (nCP) to output propagation delays.



Waveform 2. The 3-State enable and disable times.

TEST CIRCUIT



Test Circuit for switching times

DEFINITIONS

- R_L = Load resistor
- C_L = Load capacitance includes jig and probe capacitance
- R_T = Termination resistance should be equal to Z_{OUT} of pulse generators.

SWITCH POSITION

TEST	S ₁	V _{CC}	V _I
t _{pLH} /t _{pHL}	Open	< 2.7V	V _{CC}
t _{pLZ} /t _{pZL}	2 < V _{CC}	2.7-3.6V	2.7V
t _{pHZ} /t _{pZH}	GND		

SV00906

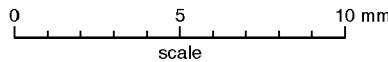
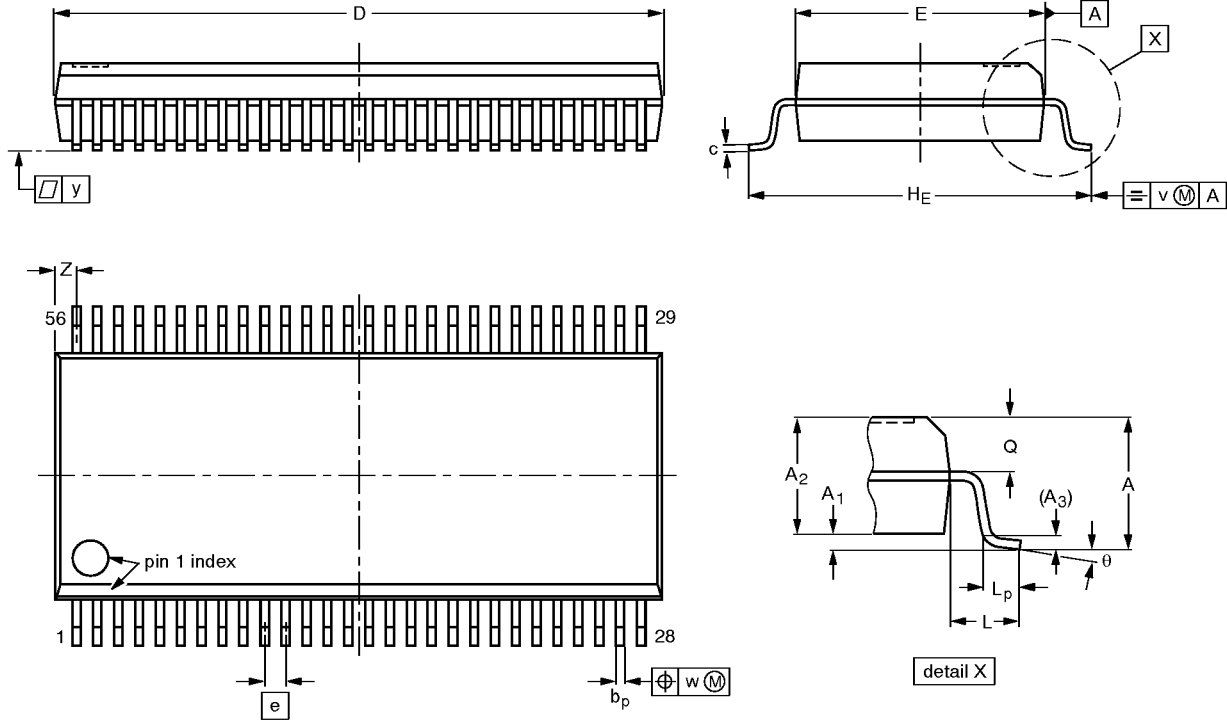
Waveform 4. Load circuitry for switching times

20-bit bus-interface D-type flip-flop;
positive-edge trigger (3-State)

74ALVCH16821

SSOP56: plastic shrink small outline package; 56 leads; body width 7.5 mm

SOT371-1



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽¹⁾	e	H _E	L	L _p	Q	v	w	y	Z ⁽¹⁾	θ
mm	2.8	0.4 0.2	2.35 2.20	0.25	0.3 0.2	0.22 0.13	18.55 18.30	7.6 7.4	0.635	10.4 10.1	1.4	1.0 0.6	1.2 1.0	0.25	0.18	0.1	0.85 0.40	8° 0°

Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

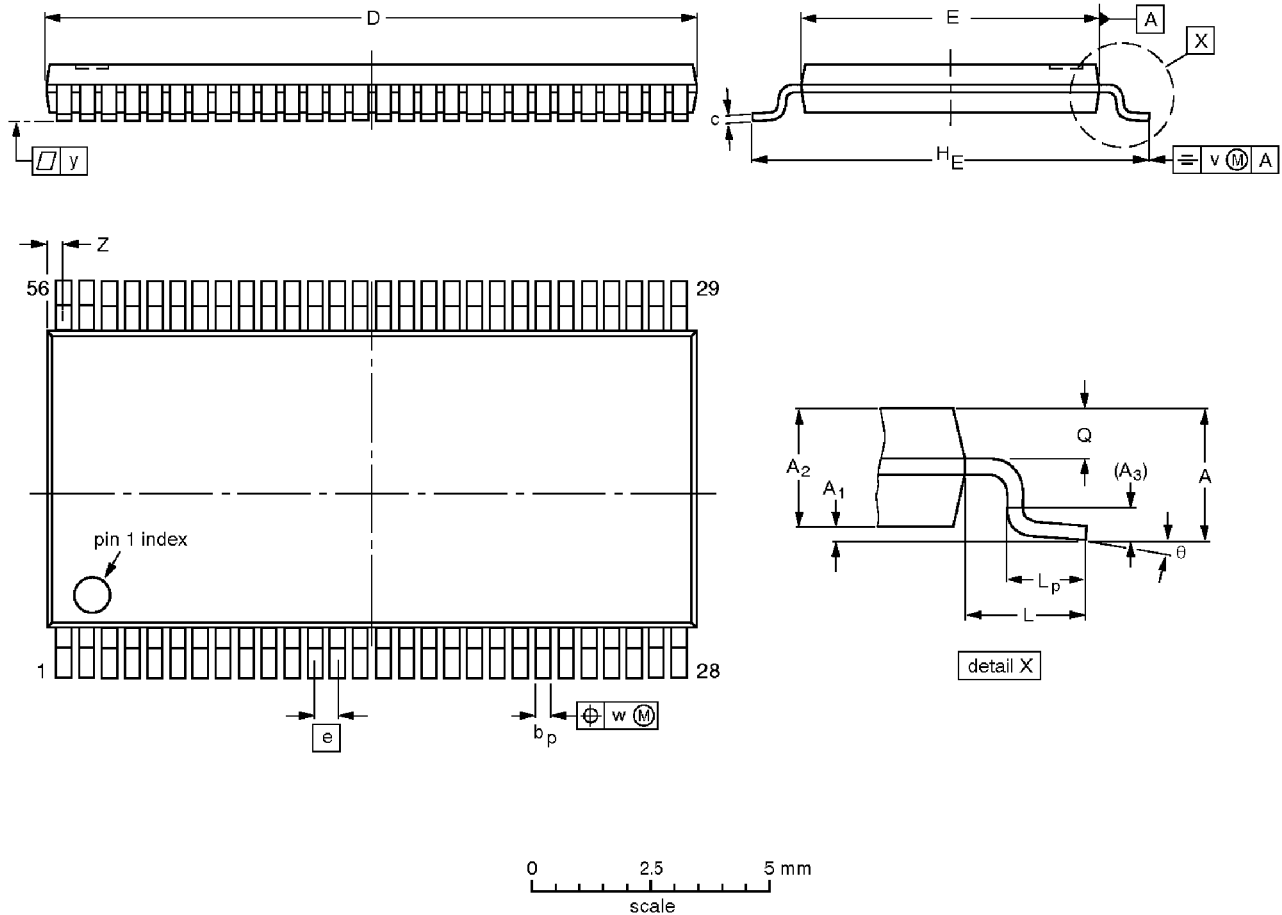
OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT371-1		MO-118AB				93-11-02- 95-02-04

20-bit bus-interface D-type flip-flop;
positive-edge trigger (3-State)

74ALVCH16821

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1mm

SOT364-1



DIMENSIONS (mm are the original dimensions).

UNIT	A max.	A ₁	A ₂	A ₃	b _p	c	D ⁽¹⁾	E ⁽²⁾	e	H _E	L	L _p	Q	v	w	y	Z	θ
mm	1.2	0.15 0.05	1.05 0.85	0.25	0.28 0.17	0.2 0.1	14.1 13.9	6.2 6.0	0.5	8.3 7.9	1.0	0.8 0.4	0.50 0.35	0.25	0.08	0.1	0.5 0.1	8° 0°

Notes

1. Plastic or metal protrusions of 0.15 mm maximum per side are not included.
2. Plastic interlead protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT364-1		MO-153EE				93-02-03 95-02-10